## **MOSFET** – Power, Single P-Channel, SOT-23 -60 V, -1.1 A, 230 m $\Omega$

#### Features

- Trench Technology
- NVR Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

#### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

Parameter		Symbol	Value	Unit		
Drain-to-Source Voltage		V <sub>DSS</sub>	-60	V		
Gate-to-Source Voltage			V <sub>GS</sub>	±20	V	
Continuous Drain Cur-	Steady	T <sub>A</sub> = 25°C	Ι <sub>D</sub>	-1.1	А	
rent $R_{\theta JA}$ (Notes 1, 2, 3)		$T_A = 100^{\circ}C$		-0.67		
Power Dissipation	State	T <sub>A</sub> = 25°C	PD	-0.47	W	
R <sub>θJA</sub> (Notes 1, 2)		$T_A = 100^{\circ}C$		0.19		
Pulsed Drain Current	$T_A = 25^{\circ}C$ , $t_p = 10 \ \mu s$		I <sub>DM</sub>	25	А	
Operating Junction and Storage Temperature		T <sub>J</sub> , T <sub>stg</sub>	–55 to +150	°C		
Source Current (Body Diode)		I <sub>S</sub>	-0.6	А		
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL RESISTANCE MAXIMUM RATINGS (Note 1)

Parameter	Symbol	Value	Unit
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	268	°C/W

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.

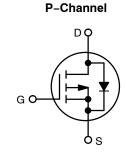
 Continuous DC current rating. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

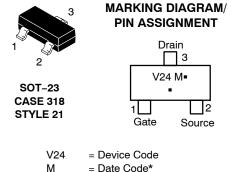


## **ON Semiconductor®**

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V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> MAX	I <sub>D</sub> MAX
–60 V	230 m $\Omega$ @ –10 V	-1.1 A
	365 mΩ @ –4.5 V	-1.1 A





= Pb–Free Package

(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NVR5124PLT1G	SOT-23 (Pb-Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

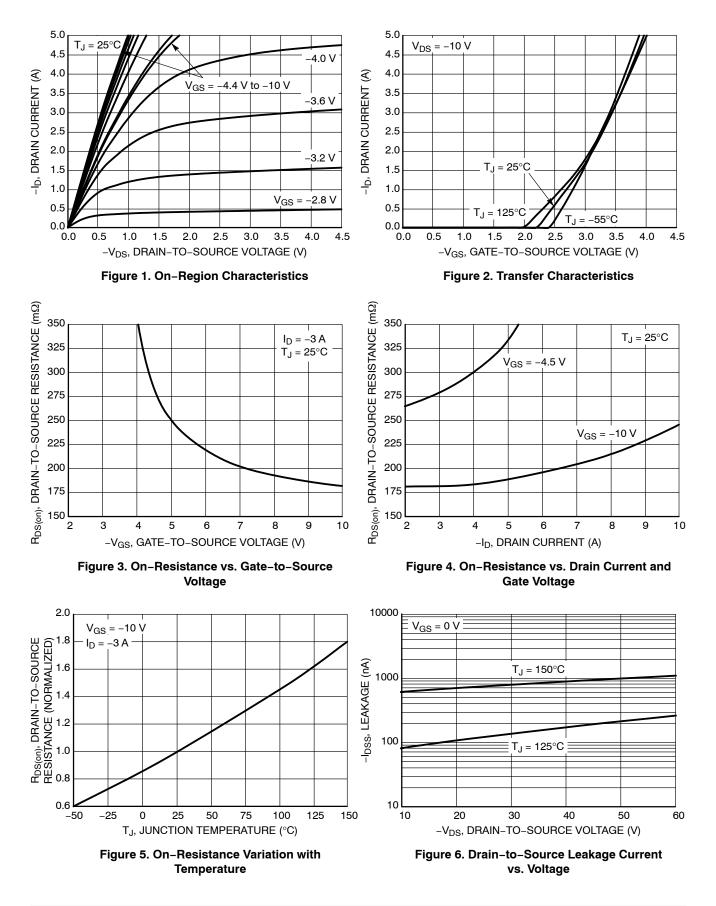
<sup>\*</sup>Date Code orientation may vary depending upon manufacturing location.

#### ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25°C unless otherwise noted)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS					•		-
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, I <sub>D</sub> =	–250 μA	-60			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = -60 V	T <sub>J</sub> = 25°C			-1.0	μΑ
			T <sub>J</sub> = 125°C			-10	
Gate-to-Source Leakage Current	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS}$	= ±20 V			±100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}, I_D =$	= –250 μA	-1.5		-2.5	V
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = -10 V,	<sub>D</sub> = -3 A		183	230	mΩ
		V <sub>GS</sub> = -4.5 V,	<sub>D</sub> = -3 A		280	365	
Forward Transconductance	9 <sub>FS</sub>	V <sub>DS</sub> = -15 V, I <sub>D</sub> = -5 A		4			S
CHARGES AND CAPACITANCES							
Input Capacitance	C <sub>iss</sub>				240		
Output Capacitance	C <sub>oss</sub>	$V_{GS}$ = 0 V, f = 1.0 MHz, $V_{DS}$ = –25 V			27.6		pF
Reverse Transfer Capacitance	C <sub>rss</sub>				18.5		
Total Gate Charge	Q <sub>G(TOT)</sub>	$V_{GS} = -4.5 \text{ V}, V_{DS} = -48 \text{ V},$ $I_D = -3 \text{ A}$ $V_{GS} = -10 \text{ V}, V_{DS} = -48 \text{ V},$ $I_D = -3 \text{ A}$			2.3		nC
Threshold Gate Charge	Q <sub>G(TH)</sub>				0.5		
Gate-to-Source Charge	Q <sub>GS</sub>				0.9		
Gate-to-Drain Charge	Q <sub>GD</sub>				1.0		
Total Gate Charge	Q <sub>G(TOT)</sub>				4.3		
SWITCHING CHARACTERISTICS (No	te 5)						
Turn-On Delay Time	t <sub>d(on)</sub>				6.6		ns
Rise Time	t <sub>r</sub>	V <sub>GS</sub> = -4.5 V, V <sub>E</sub>	<sub>IS</sub> = -48 V,		10.6		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D = -3 A, R_G$	= 2.5 Ω		12.2		
Fall Time	t <sub>f</sub>				3.5		1
DRAIN-SOURCE DIODE CHARACTER	ISTICS						
Forward Diode Voltage	V <sub>SD</sub>	$V_{GS} = 0 V,$ $I_{S} = -3 A$	$T_J = 25^{\circ}C$		-0.88	-1.0	V
			T <sub>J</sub> = 125°C		-0.76		
Reverse Recovery Time	t <sub>RR</sub>	$V_{GS} = 0 \text{ V},$ $dI_S/dt = 100 \text{ A}/\mu\text{s},$ $I_S = -3 \text{ A}$			15		ns
Charge Time	t <sub>a</sub>				13		-
Discharge Time	t <sub>b</sub>				2.4		
Reverse Recovery Charge	Q <sub>RR</sub>				10		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: Pulse Width  $\leq$  300 µs, Duty Cycle  $\leq$  2%. 5. Switching characteristics are independent of operating junction temperatures.

#### **TYPICAL CHARACTERISTICS**



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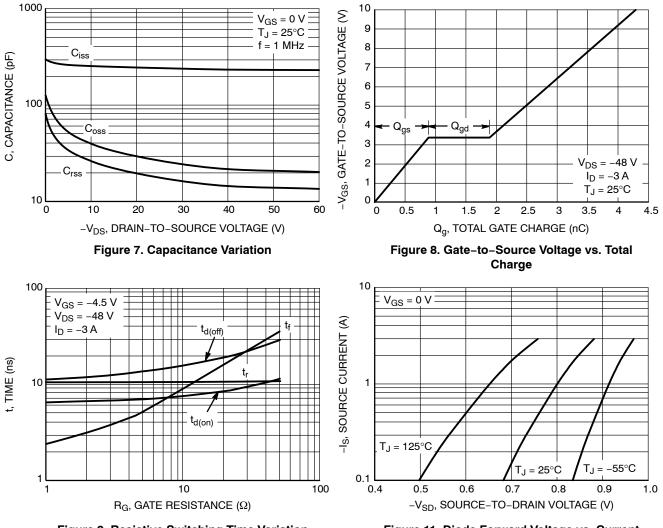
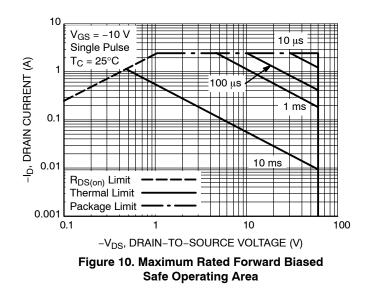


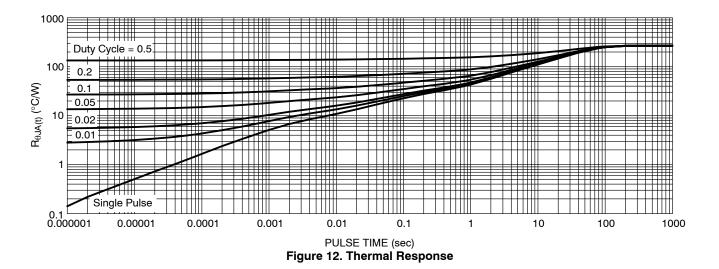
Figure 9. Resistive Switching Time Variation vs. Gate Resistance

Figure 11. Diode Forward Voltage vs. Current



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#### **TYPICAL CHARACTERISTICS**







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